## IF DOWN CONVERTOR IC FOR DIGITAL CATV

## DESCRIPTION

The $\mu$ PC2798GR is a Silicon monolithic IC designed for use as QAM IF down convertor for digital CATV. This IC consists of AGC amplifier, mixer, oscillator, and video amplifier.

The package is 20 pins SSOP suitable for high-density surface mount.

## FEATURES

- Low distortion AGC amplifier
- On chip IF convertor
- On chip video amplifier
- Supply voltage: 5 V
- Packaged in 20 pins SSOP suitable for high-density surface mount.


## ORDERING INFORMATION

| PART NUMBER | PACKAGE | PACKAGE STYLE |
| :---: | :---: | :--- |
| $\mu$ PC2798GR-E1 | 20 pins plastic SSOP (225 mil) | Embossed tape 12 mm wide. $2.5 \mathrm{k} /$ REEL. <br> Pin 1 indicates pull-out direction of tape |

*: For evaluation sample order, please contact your local NEC office.
(Part number for sample order: $\mu$ PC2798GR)

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number C11531E) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

## Caution electro-static sensitive device

[^0]
## INTERNAL BLOCK DIAGRAM AND PIN CONFIGURATION (Top View)



## PIN EXPLANATIONS

| Pin No. | Symbol | Pin Voltage (V, TYP.) | Explanation | Equivalent Circuit |
| :---: | :---: | :---: | :---: | :---: |
| 1 | AGC IN1 | 1.5 | Input pin of IF signal. <br> 1 pin is same phase and 2pin is opposite phase at balance input. <br> In case of single input, 1 pin or 2pin should be grounded through capacitor. |  |
| 2 | AGC IN2 | 1.5 |  |  |
| 3 | $V_{\text {AGC }}$ | 0 to 5 | Automatic gain control pin. <br> This pin's bias govern the AGC output level. <br> Minimum gain at $\mathrm{V}_{\mathrm{AGC}}=0 \mathrm{~V}$ <br> Maximum gain at $\mathrm{V}_{\mathrm{AGC}}=5 \mathrm{~V}$ <br> Recommend to use by deviding AGC voltage with externally resistor (ex. $100 \mathrm{k} \Omega$ ). |  |
| 4 | Vcc1 | 5.0 | Power supply pin of IF down convertor block. Must be connected bypass capacitor to minimize ground impedance. |  |
| 5 | $\begin{aligned} & \text { OSC } \\ & \text { OUT } \end{aligned}$ | 4.0 | Output pin of Oscillator frequency. <br> Connected to PLL symthesizer IC's input pin. |  |
| 6 | GND | 0.0 | Ground pin. <br> Must be connected to the system ground with minimum inductance. <br> Ground pattern on the board should be formed as wide as possible. |  |
| 7 | OSC B2 | 2.4 | Internal oscillator consist in balance amplifier. 7 and 8 pins, 9 and 10 pins should be externally connected to oscillate with active |  |
| 8 | OSC C1 | 4.6 | feedback loop. <br> Connected LC resonator between 7pin and 10pin. |  |
| 9 | OSC C2 | 4.6 |  |  |
| 10 | OSC B1 | 2.4 |  | $\xi$ |

## PIN EXPLANATIONS

| Pin No. | Symbol | Pin Voltage (V, TYP.) ( ) is value at $\mathrm{Vcc} 2=9 \mathrm{~V}$. | Explanation | Equivalent Circuit |
| :---: | :---: | :---: | :---: | :---: |
| 11 | OUT2 | $\begin{gathered} 2.5 \\ (4.7) \end{gathered}$ | Output pin of video amplifier. <br> In case of $R L=1 \mathrm{k} \Omega$, differential output voltage equal 3 V p.p. <br> OUT1 and INA are same phase. OUT2 and INB are same phase. |  |
| 11 | OUT1 | $\begin{gathered} 2.5 \\ (4.7) \end{gathered}$ |  |  |
| 13 | Vcc2 | 5 to 9 | Power supply pin of video amplifier. Must be connected bypass capacitor to minimize ground impedance. |  |
| 14 | INB | $\begin{gathered} 2.5 \\ (4.1) \end{gathered}$ | Signal input pin of video amplifier. This pin is high impedance. | (17) (15) <br> (13) <br> (14) (16) |
| 15 | INA | $\begin{gathered} 2.5 \\ (4.1) \end{gathered}$ |  |  |
| 16 | G1B | $\begin{gathered} 1.7 \\ (3.3) \end{gathered}$ | Gain control pin of video amplifier. <br> Maximum gain at G1A-GIB $=$ short. <br> Minimum gain at G1A-G1B = open. <br> Gain is able to adjust by inserting arbitrary resistor between 16pin and 17pin. |  |
| 17 | G1A | $\begin{gathered} 1.7 \\ (3.3) \end{gathered}$ |  |  |
| 18 | $\begin{aligned} & \text { MIX } \\ & \text { OUT1 } \end{aligned}$ | 3.7 | Output pin of mixer. <br> This output pin features low-impedance because of its emitter-follower output port. |  |
| 19 | $\begin{aligned} & \text { MIX } \\ & \text { OUT2 } \end{aligned}$ | 3.7 |  |  |
| 20 | GND | 0.0 | Ground pin. <br> Must be connected to the system ground with minimum inductance. <br> Ground pattern on the board should be formed as wide as possible. |  |

## ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise specified)

| PARAMETER | SYMBOL | RATING | UNIT | TEST CONDITIONS |
| :--- | :---: | :---: | :---: | :--- |
| Supply Voltage 1 | Vcc1 | 6.0 | V | Mixer block |
| Supply Voltage 2 | Vcc 2 | 6.0 | V | Video Amp block |
| Power Dissipation | $\mathrm{PD}_{\mathrm{D}}$ | 430 | mW | $\mathrm{~T}_{\mathrm{A}}=85^{\circ} \mathrm{C}^{\circ}{ }^{1}$ |
| Operating Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage Temperature | $\mathrm{T}_{\mathrm{stg}}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |  |


| PARAMETER | SYMBOL | RATING | UNIT | TEST CONDITIONS |
| :--- | :---: | :---: | :---: | :--- |
| Supply Voltage 1 | Vcc1 | 6.0 | V | Mixer block |
| Supply Voltage 2 | Vcc 2 | 11.0 | V | Video Amp block |
| Power Dissipation | $\mathrm{PD}_{\mathrm{D}}$ | 500 | mW | $\mathrm{~T}_{\mathrm{A}}=75^{\circ} \mathrm{C}^{\circ}{ }^{1}$ |
| Operating Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ | -40 to +75 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |  |

*1. Mounted on $50 \times 50 \times 1.6 \mathrm{~mm}$ double copper epoxy glass board.

## RECOMMENDED OPERATING RANGE

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage 1 | Vcc1 | 4.5 | 5.0 | 5.5 | V |
| Supply Voltage 2 | Vcc2 | 4.5 | 5.0 | 10.0 | V |
| Operating Ambient Temperature $1^{12}$ | TA1 | -40 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Operating Ambient Temperature $2^{\circ}{ }^{\text {3 }}$ | TA2 | -40 | +25 | +75 | ${ }^{\circ} \mathrm{C}$ |

*2. $@ \mathrm{Vcc} 1=\mathrm{Vcc} 2=4.5$ to 5.5 V
*3. $@ \vee c c 1=4.5$ to $5.5 \mathrm{~V}, \mathrm{Vcc} 2=4.5$ to 10.0 V

## ELECTRICAL CHARACTERISTICS (TA = $25^{\circ} \mathrm{C}$ )

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Total Block ( $R \mathrm{~L}=1 \mathrm{k} \Omega$, by measurement circuit 5) |  |  |  |  |  |  |
| Circuit Current 1 | Icc1 | 24.0 | 35.5 | 45.0 | mA | no input signal, Vcc1 = Vcc2 $=5 \mathrm{~V}$ |
| Maximum Conversion Gain 1 | CGmax 1 | 68.0 | 74.0 | 76.0 | dB | $\mathrm{V}_{\text {AGC }}=4.0 \mathrm{~V}, \mathrm{G1A}$-G1B pins: short $^{4}$ |
| Maximum Conversion Gain 2 | CGmax2 | - | 58.0 | - | dB | $\mathrm{V}_{\text {AGC }}=4.0 \mathrm{~V}, \mathrm{G1A}$-G1B pins: open $^{4}$ |
| Minimum Conversion Gain 1 | CGmin 1 | 32.0 | 39.0 | 43.0 | dB | $\mathrm{V}_{\text {AGC }}=1.0 \mathrm{~V}, \mathrm{G1A}$-G1B pins: short $^{4}{ }^{4}$ |
| Minimum Conversion Gain 2 | CGmin2 | - | 22.0 | - | dB | $\mathrm{V}_{\text {AGC }}=1.0 \mathrm{~V}, \mathrm{G1A}$-G1B pins: open $^{* 4}$ |
| Circuit Current 2 | Icc1 | 32.0 | 47.0 | 60.0 | mA | no input signal, Vcc1 $=5 \mathrm{~V}, \mathrm{Vcc2}=9 \mathrm{~V}$ |
| Maximum Conversion Gain 3 | CGmax3 | 72.0 | 78.5 | 81.0 | dB | $\mathrm{V}_{\text {AGC }}=4.0 \mathrm{~V}, \mathrm{G1A}$-G1B pins: short $^{+4}$ |
| Maximum Conversion Gain 4 | CGmax4 | - | 59.0 | - | dB | $\mathrm{V}_{\text {AGC }}=4.0 \mathrm{~V}, \mathrm{G1A}$-G1B pins: open $^{* 4}$ |
| Minimum Conversion Gain 3 | CGmin3 | - | 43.5 | - | dB | $\mathrm{V}_{\text {AGC }}=1.0 \mathrm{~V}, \mathrm{G1A}$-G1B pins: short $^{*}{ }^{4}$ |
| Minimum Conversion Gain 4 | CGmin4 | - | 22.5 | - | dB | $\mathrm{V}_{\text {AGC }}=1.0 \mathrm{~V}, \mathrm{G1}$ A-G1B pins: open $^{* 4}$ |

ELECTRICAL CHARACTERISTICS (TA $=25^{\circ} \mathrm{C}$ )

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AGC Amplifier + Mixer Block (@Vcc1 = 5 V, RL= $=50 \Omega$, by measurement circuit 1) |  |  |  |  |  |  |
| Circuit Current 3 | Icc3 | 15.0 | 23.0 | 28.0 | mA | no input signal |
| RF Input Frequency Range | $\mathrm{ffF}^{\text {f }}$ | 30 | - | 250 | Mhz |  |
| OSC Frequency Range | fosc | 30 | - | 250 | Mhz |  |
| IF Output Frequency Range | $\mathrm{fiF}^{\text {F }}$ | DC | - | 150 | Mhz |  |
| Minimum Conversion Gain 5 | CGmax5 | - | 25 | - | dB | $\mathrm{V}_{\text {AGC }}=4.0 \mathrm{~V}^{\text {4 }}$ |
| Minimum Conversion Gain 5 | CGmin5 | - | -7 | - | dB | $V_{\text {AGC }}=1.0 \mathrm{~V}^{\text {/4 }}$ |
| AGC Dynamic Range | GCR | 26 | 32 | - | dB | $V_{\text {AGC }}=1.0$ to 4.0 V |
| Noise Figure | NF | - | 9 | - | dB | SSB, V $\mathrm{VAGC}^{\text {a }}=4.0 \mathrm{~V}$ (@Maximum Gain) ${ }^{* 4,5}$ |
| AGC Voltage High Level | $\mathrm{V}_{\text {agch }}$ | 4.0 | - | - | V | @Maximum Gain |
| AGC Voltage Low Level | $V_{\text {AGGL }}$ | - | - | 1.0 | V | @Minimum Gain |
| Video Amp. Block (@Vcc2 = 5 V, RL = $1 \mathrm{k} \Omega$, Input: $51 \Omega$ terminated, by measurement circuit 3) |  |  |  |  |  |  |
| Circuit Current 4 | Icc4 | 9.0 | 12.5 | 17.0 | mA | no input signal |
| Differential Gain 1 | G1 | - | 200 | - | V/V | $\begin{aligned} & \text { G1A-G1B pins: short, Vout }=3.0 \text { VP-P, } \\ & \text { fin }=10 \mathrm{MHz} \end{aligned}$ |
| Differential Gain 2 | G2 | - | 26.0 | - | V/V | $\begin{aligned} & \text { G1A-G1B pins: open, Vout }=3.0 \mathrm{VP}-\mathrm{P}, \\ & \text { fin }=10 \mathrm{MHz} \end{aligned}$ |
| Video Amp. Block (@Vcc2 = $9 \mathrm{~V}, \mathrm{RL}=1 \mathrm{k} \Omega$, Input: $51 \Omega$ terminated, by measurement circuit 3) |  |  |  |  |  |  |
| Circuit Current 5 | Icc5 | 17.0 | 24.0 | 32.0 | mA | no input signal |
| Differential Gain 3 | G3 | - | 385 | - | V/V | $\begin{aligned} & \text { G1A-G1B pins: short, Vout = 3.0 VP-P, } \\ & \text { fin }=10 \mathrm{MHz} \end{aligned}$ |
| Differential Gain 4 | G4 | - | 28.5 | - | V/V | G1A-G1B pins: open, Vout $=3.0$ VP-P, fin $=10 \mathrm{MHz}$ |
| Video Amp. Block (@Vcc2 = 5 V or 9 V : Common, RL= $1 \mathrm{k} \Omega$, Input: $51 \Omega$ terminated, by measurement circuit 3) |  |  |  |  |  |  |
| Output Voltage | Vout | - | 3.0 | - | Vp-P | $\mathrm{RL}=1 \mathrm{k} \Omega$, differential |
| Bandwidth 1 | BWG1 | - | 50 | - | MHz | G1 (G1A-G1B pins: short) |
| Bandwidth 2 | BWG2 | - | 50 | - | MHz | G2 (G1A-G1B pins: open) |
| Input Resistance 1 | Rin1 | - | 3.5 | - | $\mathrm{k} \Omega$ | G1 (G1A-G1B pins: short) |
| Input Resistance 2 | Rin2 | - | 9.7 | - | $\mathrm{k} \Omega$ | G2 (G1A-G1B pins: open) |
| Input Capacitance | Cin | - | 1.6 | - | pF |  |

*4. $\mathrm{fRF}=45 \mathrm{MHz}$, fosc $=55 \mathrm{MHz}$, Posc $=-10 \mathrm{dBm}$
*5. By measurement circuit 2

STANDARD CHARACTERISTICS (TA $=25^{\circ} \mathrm{C}$ )

| PARAMETER | SYMBOL | VALUE FOR REFERENCE | UNIT | TEST CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AGC Amplifier + Mixer Block (@Vcc1 = 5 V, by measurement circuit 1) |  |  |  |  |  |
| AGC Input Intercept Point 1 | $\begin{aligned} & \text { AGC } \\ & \text { IIP }_{3} 1 \end{aligned}$ | -9 | dBm | $\mathrm{V}_{\text {AGC }}=1.0 \mathrm{~V}$ @Minimum Gain | *6 |
| Video Amp. Block ( $\mathrm{RL}=50 \Omega$, input: $51 \Omega$ terminated, by measurement circuit 4) |  |  |  |  |  |
| Single-end Gain 1 | Avs1 | 40.0 | dB | Vcc2 $=5 \mathrm{~V}, \mathrm{G} 1 \mathrm{~A}-\mathrm{G} 1 \mathrm{~B}$ pins: short |  |
| Single-end Gain 2 | Avs2 | 22.5 | dB | Vcc2 $=5 \mathrm{~V}$, G1A-G1B pins: open |  |
| Single-end Gain 3 | Avs3 | 45.0 | dB | Vcc2 $=9 \mathrm{~V}$, G1A-G1B pins: short |  |
| Single-end Gain 4 | Avs4 | 23.5 | dB | Vcc2 $=9 \mathrm{~V}$, G1A-G1B pins: open |  |
| Input Intercept Point 2 | IIP32 | -11.5 | dBm | $\mathrm{Vcc} 2=5 \mathrm{~V}$, G1A-G1B pins: open fin1 $=9 \mathrm{MHz}$, fin2 $=11 \mathrm{MHz}$ |  |
| Input Intercept Point 3 | IIP33 | -5.0 | dBm | $\mathrm{Vcc} 2=9 \mathrm{~V}$, G1A-G1B pins: open fin1 $=9 \mathrm{MHz}$, fin2 $=11 \mathrm{MHz}$ |  |
| Video Amp. Block (@Vcc2 = 5 V or 9 V: Common, by measurement circuit 3) |  |  |  |  |  |
| Common Mode Rejection Ratio | CMRR | 80 | dB | $\mathrm{V}_{\mathrm{CM}}=1 \mathrm{VP-P}, \mathrm{f}=100 \mathrm{kHz}$ |  |
| Power Supply Rejection Ratio | PSRR | 70 | dB |  |  |
| Rise Time | $\tau_{R}$ | 2.6 | ns |  |  |
| Propagation Delay Time | тPD | 4.4 | ns |  |  |
| Total Block ( $\mathrm{RL}=1 \mathrm{k} \Omega$, by measurement circuit 5) |  |  |  |  |  |
| Input Intercept Point 4 | IIP34 | -14.0 | dBm | $V_{c c} 1=V_{C c} 2=5 \mathrm{~V}, V_{A G C}=1 \mathrm{~V},$ <br> G1A-G1B pins: short | *6 |
| Input Intercept Point 5 | IIP35 | -8.0 | dBm | $V_{C C 1}=V_{C C 2}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{AGC}}=1 \mathrm{~V},$ <br> G1A-G1B pins: open | *6 |
| Input Intercept Point 6 | IIP36 | -7.5 | dBm | $\mathrm{V}_{\mathrm{cc}} 1=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{cc}} 2=9 \mathrm{~V}, \mathrm{~V}_{\mathrm{AGC}}=1 \mathrm{~V},$ <br> G1A-G1B pins: open | *6 |

*6 $f_{\text {RF }} 1=44 \mathrm{MHz}, \mathrm{frF}_{\mathrm{R}}=46 \mathrm{MHz}, \mathrm{fosc}=55 \mathrm{MHz}, \operatorname{Posc}=-10 \mathrm{dBm}$

TYPICAL CHARACTERISTICS
(by measurement circuit $5, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, fosc $=\mathrm{frF}+10 \mathrm{MHz}, \mathrm{Posc}=-10 \mathrm{dBm}$ )



CONVERSION GAIN vs. INPUT FREQUENCY


CONVERSION GAIN vs. INPUT FREQUENCY


## TYPICAL CHARACTERISTICS

(by measurement circuit $5, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{frF}=45 \mathrm{MHz}$, $\mathrm{Posc}=-10 \mathrm{dBm}$ )


CONVERSION GAIN vs. INTERMEDIATE FREQUENCY




## TYPICAL CHARACTERISTICS (by measurement circuit $1, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )



STANDARD CHARACTERISTICS (by measurement circuit $3, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )


STANDARD CHARACTERISTICS (by measurement circuit 4, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )






## STANDARD CHARACTERISTICS (by measurement circuit 5)





## STANDARD CHARACTERISTICS

(by application circuit example: MIXER block, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )






## MEASUREMENT CIRCUIT 1

<AGC + MIX block>


## MEASUREMENT CIRCUIT 2

<AGC + MIX block>


## MEASUREMENT CIRCUIT 3

<Video Amp. block>


## MEASUREMENT CIRCUIT 4

<Video Amp. block>

*7: In case of measurement of IIP3

## MEASUREMENT CIRCUIT 5

<Total block>

*8: In case of measurement of IIP3

## APPLICATION CIRCUIT EXAMPLE



Cv: $N$ ratio $=10$ to 11 (ex. HVU 200 A )
The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

## ILLUSTRATION OF THE APPLICATION CIRCUIT ASSEMBLED ON EVALUATION BOARD



## Notes

*1) $R$ is resistance to control video amplifier gain. (short to open)
*2) Cv is variable capacitor. ( N ratio $=10$ to 11, Example: HVU200A)
*3) $\quad \bigcirc$ shows through holes
*4) $\mathscr{W}$ pattern should be removed on this application

## PACKAGE DIMENSIONS

## $\star 20$ PIN PLASTIC SSOP (225 mil) (UNIT: mm)


detail of lead end


NOTE Each lead centerline is located within 0.10 mm of its true position (T.P.) at maximum material condition.

## RECOMMENDED SOLDERING CONDITIONS

The following conditions (see table below) must be met when soldering this product.
Please consult with our sales officers in case other soldering process is used or in case soldering is done under different conditions.

For details of recommended soldering conditions for surface mounting, refer to information document SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E).
$\mu \mathrm{PC} 2798 \mathrm{GR}$

| Soldering process | Soldering conditions | Symbol |
| :---: | :---: | :---: |
| Infrared ray reflow | Peak package's surface temperature: $235^{\circ} \mathrm{C}$ or below, Reflow time: 30 seconds or below ( $210^{\circ} \mathrm{C}$ or higher), Number of reflow process: 3, Exposure limit ${ }^{\text {Note }}$ : None | IR35-00-3 |
| VPS | Peak package's surface temperature: $215^{\circ} \mathrm{C}$ or below, Reflow time: 40 seconds or below ( $200^{\circ} \mathrm{C}$ or higher), Number of reflow process: 3, Exposure limit ${ }^{\text {Note }}$ : None | VP15-00-3 |
| Partial heating method | Terminal temperature: $300^{\circ} \mathrm{C}$ or below, Flow time: 3 seconds or below, Exposure limit ${ }^{\text {Note }}$ : None |  |

Note Exposure limit before soldering after dry-pack package is opened.
Storage conditions: $25^{\circ} \mathrm{C}$ and relative humidity at $65 \%$ or less.

Caution Do not apply more than single process at once, except for "Partial heating method".
[MEMO]
[MEMO]

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Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.
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